PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Scott Jansen	12/14/2007

RECEIVING PARTY DATA

Name:	Infineon Technologies North America Corp.	
Street Address:	640 N. McCarthy Blvd.	
City:	Milpitas	
State/Country:	CALIFORNIA	
Postal Code:	95035	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11694449

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 2007P52505US

NAME OF SUBMITTER: Heather Rowland

Total Attachments: 1

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. \$40.00

PATENT REEL: 020281 FRAME: 0913

Atty. Docket No.: 2007P52505US

ASSIGNMENT

For good and valuable consideration, I, Scott Jansen, a US citizen residing at 1300 30th Street. Apt. B3-16, Boulder, CO 80303, hereinafter individually or collectively referred to as "Assignor",

Hereby sell, assign and transfer to Infineon Technologies North America Corp., a corporation organized and existing under the state laws of Delaware, having its principal place of business at 640 N. McMarthy Blvd., Milpitas, CA 95035, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest, in and for the United States and all foreign countries, in and to any and all inventions which are disclosed in the application for United States Letters patent, and which has been executed by the undersigned and filed herewith, entitled:

Semiconductor Integrated Test Structures for Electron Beam Inspection of Semiconductor Wafers

in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said inventions; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said inventions;

Assignor agrees that Assignee may apply for and receive Letters Patent for said inventions in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said inventions; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to Assignee, facts known to the undersigned relating to said inventions and the history thereof; and generally do everything possible which Assignee shall consider desirable for aiding in securing and mainlining proper patent protection for said inventions and for vesting title to said inventions, and all applications for patents and all patents on inventions in said Assignee;

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the dame as herein expressed is possessed by the undersigned.

RECORDED: 12/21/2007

PATENT

REEL: 020281 FRAME: 0914